Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:		NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		ASSIGNMENT			
CONVEYING PART	Υ ΟΑΤΑ				
		Execution Date			
O Bum KWON			04/14/2008		
Kil Sung LEE			04/14/2008		
Jae Hyun KIM			04/14/2008		
Jung Hyun KIM			04/14/2008		
RECEIVING PARTY	′ DATA				
Name:	Cheil Industries Inc.				
Street Address:	290 Gongdan 2-dong				
Internal Address:	Gumi-si				
City:	Gyeongsangbuk-do				
State/Country:	REPUBLIC OF KOREA				
Postal Code:	730-710				
Property Type		Number			
Application Number: 121		16314			
CORRESPONDENC	CE DATA				
Fax Number: (704)945-6735					
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.					
Phone: 704-945-6700					
Email: rowens@summalaw.com					
Correspondent Name:Melissa B. PendletonAddress Line 1:11610 N. Community House Road					
Address Line 2: Suite 200					
Address Line 4:					
ATTORNEY DOCKET NUMBER:		7016.024US2			
NAME OF SUBMITTER:		Melissa B. Pendleton			
][PATENT		
500533100 REEL: 020912 FRAME: 0245					

Total Attachments: 4 source=AssignmentUSPTO#page1.tif source=AssignmentUSPTO#page2.tif source=AssignmentUSPTO#page3.tif source=AssignmentUSPTO#page4.tif Form PTO-1595 (Rev. 08/05) OMB No. 0651-0027 (exp. 6/30/2008) U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office

RECORDATION FORM COVER SHEET PATENTS ONLY					
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.					
 Name of conveying party(ies) 1) O Bum KWON 2) Kil Sung LEE 3) Jae Hyun KIM 4) Jung Hyun KIM 	2. Name and address of receiving party(ies) Name: Cheil Industries, Inc. Internal Address:				
A. Patent Application No.(s)	Street Address: 290, Gongdan 2-dong, Gumi-si, City: Gyeongsangbuk-do State:				
12/116,314 Additional numbers at 5. Name and address to whom correspondence concerning document should be mailed:	tached? Yes XNo 6. Total number of applications and patents involved: 1				
Name: Summa, Allan & Additon, P.A.	7. Total fee (37 CFR 1.21(h) & 3.41) \$ <u>40.00</u>				
Internal Address:	Authorized to be charged by credit card Authorized to be charged to deposit account Enclosed None required (government interest not affecting title)				
Street Address: 11610 N. Community House Road, Suite 200					
City: Charlotte	8. Payment Information				
State: NC Zip: 28277-2199	a. Credit Card Last 4 Numbers Expiration Date				
Phone Number: 704-945-6700 Fax Number: 704-945-6735 Email Address: mpendleton@summalaw.com	b. Deposit Account Number <u>50-0332</u> Authorized User Name Melissa B. Pendleton				
9. Signature: /Melissa B. Pendleton/					
Signature Melissa B. Pendleton Name of Person Signing	Date Total number of pages including cover sheet, attachments, and documents:				

Documents to be recorded (Including cover sheet) should be faxed to (571) 273-0140, or mailed to:

Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

ASSIGNMENT

. . .

WHEREAS, I, O Bum KWON, a Korean citizen, residing at 27-55, Wonhyoro 1-ga, Yongsan-gu, Seoul, Republic of Korea; Kil Sung LEE, a Korean citizen, residing at 913-104 Jugong Apt., 41 Burim-dong, Gwacheon-si, Gyeonggi-do, Republic of Korea; Jae Hyun KIM, a Korean citizen, residing at Room #1009, Trapalace, Sunae-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Republic of Korea; and Jung Hyun KIM, a Korean citizen, residing at 106-1402, Woolim FillU Apt., Chilgoidong, Pyeongtaek-si, Gyeonggi-do, Republic of Korea (hereinafter collectively referred to as "ASSIGNOR"), am a joint inventor of certain new and useful improvements (hereinafter collectively referred to as "INVENTION") in Thermosetting Resin Composition for Producing Color Filter for CMOS Image Sensor, Color Filter Comprising Transparent Film Formed Using the Composition and CMOS Image Sensor Using the Color Filter, for which a application for United States Letters Patent is being filed concurrently herewith, which application is a continuation-in-part application of pending U.S. Application Serial No. 11/965,856 filed on December 28, 2007, which itself claims priority from a Korean Patent Application filed on June 19, 2007, under Ser. No. 10-2007-0059842, all applications listed above being hereinafter referred to as the "APPLICATION"; and

> WHEREAS, Cheil Industries Inc., a Korean corporation (hereinafter referred to as "ASSIGNEE"), having a principal place of business at 290 Gongdan-dong, Gumi-si, Gyeongsangbuk-do 730-710, Republic of Korea, has acquired the equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in

> > PATENT REEL: 020912 FRAME: 0248

and to any and all Letters Patent that shall be granted with respect to said INVENTION in the United States of America and all foreign countries;

.....

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors and assigns, my equitable right, title, and interest—and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interest—in and to said INVENTION and APPLICATION, in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be

granted, together with the right to claim the priority of said APPLICATION in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if an assignment and sale had not been made.

> I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to

2

said ASSIGNEE or its representatives any facts known to me relating to said INVENTION, to testify in any interference or legal proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

2008/4/14	_, 2008	<u>FI</u> Euth O BUM KWON
Apr. 14	_, 2008) de Jee Kil Sung LEE
April 14, 2008	_, 2008	Jag Kin Jag Myun KIM
April 14	_, 2008	N2 26m

Jung Hyun KIM

S:\FTRM DOCS\7016\24US2\ASSIGNMENT 7016.024US2.doc

a second and a second second

.

RECORDED: 05/07/2008